

Innovative Service Around the Globe

DATA SHEET

SURFACE MOUNT MULTILAYER CERAMIC CAPACITORS

Automotive grade HiCap X7R

6.3 V TO 100 V I μF to 10 μF RoHS compliant & Halogen Free



YAGEO

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Surface-Mount Ceramic Multilayer Capacitors Automotive grade X7R 6.3 V to 100 V

<u>SCOPE</u>

This specification describes Automotive grade X7R series chip capacitors with lead-free terminations and used for automotive equipments.

APPLICATIONS

All general purpose applications Entertainment applications Comfort / security applications Information applications

FEATURES

- AEC-Q200 qualified
- MSL class: MSL I
- AC series soldering is compliant with J-STD-020D
- High component and equipment reliability
- The capacitors are 100% performed by automatic optical inspection prior to taping.

ORDERING INFORMATION - GLOBAL PART NUMBER

All part numbers are identified by the series, size, tolerance, TC material, packing style, voltage, process code, termination and capacitance value.

GLOBAL PART NUMBER

AC <u>XXXX</u> <u>X</u> <u>X</u> <u>XXX</u> <u>X</u> B <u>X</u> <u>XXX</u> (1) (2) (3) (4) (5) (6) (7)

(I) SIZE - INCH BASED (METRIC)

0201 (0603) / 0402 (1005) / 0603 (1608) / 0805 (2012) / 1206 (3216)/ 1210 (3225) /1812 (4532)

(2) TOLERANCE

- J = ±5%
- $K = \pm 10\%$ M = $\pm 20\%$

Capacitance tolerance $\pm 5\%$ doesn't available for X7R full product range, please contact local sales before order

(3) PACKING STYLE

- R = Paper/PE taping reel; Reel 7 inch
- K = Blister taping reel; Reel 7 inch
- P = Paper/PE taping reel; Reel 13 inch
- F = Blister taping reel; Reel 13 inch

(4) TC MATERIAL

X7R

(5) RATED VOLTAGE

$4 = 4 \vee$
5 = 6.3 V
6 = I0V
7 = 16 V
8 = 25 V
G = 35 V
9 = 50 V
$0 = 100 \vee$

(6) PROCESS

B = X7R

(7) CAPACITANCE VALUE

2 significant digits + number of zeros

The 3rd digit signifies the multiplying factor, and letter R is decimal point

Example: $|2| = |2 \times |0| = |20 \text{ pF}$

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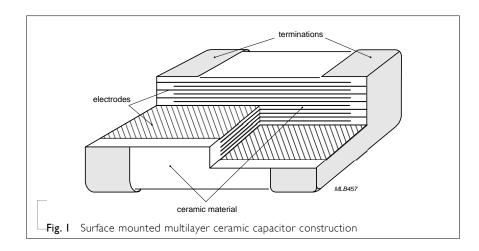
CONSTRUCTION

The capacitor consists of a rectangular block of ceramic dielectric in which a number of interleaved metal electrodes are contained. This structure gives rise to a high capacitance per unit volume.

The inner electrodes are connected to the two end terminations and finally covered with a layer of plated tin (Matte Sn). The terminations are leadfree. A cross section of the structure is shown in Fig.1.

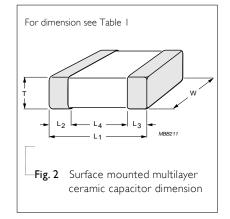
DIMENSION

-Table I For outlines see fig. 2



TYPE	L _I (mm)	W (mm)	T (MM)	L ₂ / L ₃ (r min.	nm) max.	L ₄ (mm) min.	
0201	0.6 ±0.03	0.3±0.03	0.3±0.03	0.10	0.20	0.20	
0402	1.0 ±0.05	0.5 ±0.05	0.5 ±0.05	0.15	0.35	0.40	
0603	1.6 ±0.10	0.8 ±0.10	0.8 ±0.10	0.20	0.60	0.40	
			0.6 ±0.10				
0805	2.0 ±0.10	1.25 ±0.10	0.85 ±0.10	0.25	0.75	0.70	
	2.0 ±0.20	1.25 ±0.20	1.25 ±0.20				
	3.2 ±0.15		0.6 ±0.10				
	5.2 ±0.15	1.6 ±0.15	0.85 ±0.10	0.25		1.40	
1206			1.15 ± 0.10		0.75		
1200	3.2 ±0.30	1.6 ±0.20	1.25 ±0.20		0.75		
			1.6 ±0.20				
	3.2 ±0.30	1.6 ±0.30	1.6 ±0.30				
	224020		0.85 ±0.10				
	3.2 ±0.20	2.5 ±0.20	1.25 ±0.20				
1210	3.2 ±0.30	2.5 ±0.20	1.6 ±0.20	0.25	0.75	1.40	
	3.2 ±0.30	2.5 ±0.20	2.0 ±0.20				
	3.2 ±0.40	2.5 ±0.30	2.5 ±0.20				
1808	4.5 ±0.40	2.0 ±0.30	1.25 ±0.20	0.25	0.75	2.20	
	4.5 ±0.40		0.85 ±0.10		0.75		
1812		3.2 ±0.30	1.25 ±0.20	0.25		2.20	
			1.6 ±0.20				

OUTLINES



CAPACITANCE RANGE & THICKNESS FOR X7R

Table 2	Sizes from	0603 to	0805
		0005 10	0005

(CAP.	0603				0805					
_		6.3V	10V	16 V	25 V	6.3 V	10 V	16 V	25 V	35 V	50 V
	ΙμF	0.8±0.1	0.8±0.1	0.8±0.1	0.8±0.1		1.25±0.2	1.25±0.2	1.25±0.2		1.25±0.2
	2.2 uF						1.25±0.2	1.25±0.2	1.25±0.2	1.25±0.2	
	4.7 uF						1.25±0.2	1.25±0.2			
	10 uF					1.25±0.2					

Table 3 Sizes 1206

CAP. 1206

	6.3 V	10V	16V	25V	50 V	100 V
ΙμF		1.15±0.10	1.15±0.10	1.60±0.2	1.60±0.2	1.60±0.2
2.2 µF			1.60±0.2	1.60±0.2	1.60±0.2	1.60±0.2
4.7 uF	1.60±0.2	1.60±0.2	1.60±0.2			
10 uF						

Table 4	Sizes 12	10 to 1812			
CAP.	1210			1812	
	25 V	50V	100 V	50V	100V
ΙμF	1.25±0.20	1.25±0.20	2.0±0.2	1.60±0.2	1.60±0.2
2.2 µF		2.0±0.2	2.0±0.2		
4.7 µF	2.5±0.2	2.5±0.2			

ΝΟΤΕ

I. Values in shaded cells indicate thickness class in mm

2. Capacitance value of non E-6 series is on request

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THICKNESS CLASSES AND PACKING QUANTITY

Table 5								
		раски	NG CODE	_		QUANTITY	Y PER REEL	
SIZE CODE	THICKNESS	FACKI	NG CODE	TAPE WIDTH	Ø180 MN	1/7 INCH	Ø330 MM / 13 INCH	
	CLASSIFICATION	7 INCH	13 INCH		Paper	Blister	Paper	Blister
0201	0.3 ±0.03 mm	R	Р	8 mm	15,000		50,000	
0402	0.5 ±0.05 mm	R	Р	8 mm	10,000		50,000	
0603	0.8 ±0.1 mm	R	Р	8 mm	4,000		15,000	
	0.6 ±0.1 mm	R	Р	8 mm	4,000		20,000	
0805	0.85 ±0.1 mm	R	Р	8 mm	4,000		15,000	
	1.25 ±0.2 mm	К	F	8 mm		3,000		10,000
_	0.6 ±0.1 mm	R	Ρ	8 mm	4,000		20,000	
1206 -	0.85 ±0.1 mm	R	Р	8 mm	4,000		5,000	
1200	1.0/1.15 ±0.1 mm	К	F	8 mm		3,000		10,000
	1.25 ±0.2 mm	К	F	8 mm		3,000		10,000
_	0.85 ±0.1 mm	К	F	8 mm		4,000		10,000
	1.15 ±0.1 mm	К	F	8 mm		3,000		10,000
1210	1.25 ±0.2 mm	К	F	8 mm		3,000		10,000
	2.0 ±0.2 mm	К		8 mm		2,000		
	2.5 ±0.2 mm	К		8 mm		I ,000		
	0.6 / 0.85±0.1 mm	К		l2 mm		2,000		
1812 -	1.15±0.1 mm	К		l2 mm		000, ا		
1012	1.25±0.2 mm	К		l2 mm		000, ا		
	1.6 ±0.2 mm	К		l2 mm		2,000		

PAPER/PE TAPE SPECIFICATION

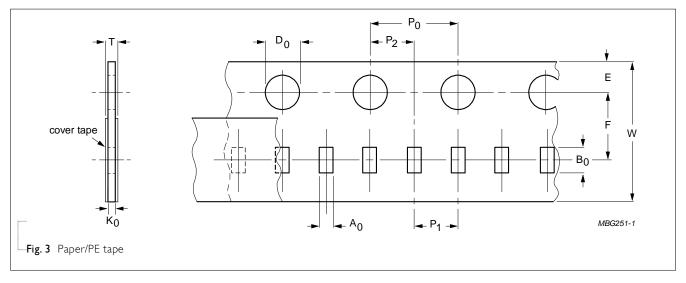


Table 6 Dimensions of paper/PE tape for relevant chip size; see Fig.3

SIZE	SYMBOL Unit: mm											
CODE	A ₀	B ₀	W	E	F	$P_0^{(1)}$	PI	P ₂	ØD ₀	K ₀	Т	
0201	0.39 ± 0.06	0.70 ± 0.06	8.0 ± 0.20	1.75 ± 0.1	3.50 ± 0.05	4.0 ± 0.05	2.0 ± 0.05	2.0 ± 0.05	1.55 ± 0.03	0.38 ± 0.05	(0.47 / 0.55)±0.10	
0402	0.70 ± 0.15	1.21 ± 0.12	8.0 ± 0.20	1.75 ± 0.1	3.50 ± 0.05	4.0 ± 0.05	2.0 ± 0.05	2.0 ± 0.05	1.50 +0.1 /-0	(0.75 / 0.60)±0.10	(0.85 / 0.70)±0.10	
0603	1.05 ± 0.14	1.86 ± 0.13	8.0 ± 0.20	1.75 ± 0.1	3.50 ± 0.05	4.0 ± 0.10	4.0 ± 0.10	2.0 ± 0.05	1.50 +0.1 /-0	(1.05 / 0.95 / 0.75)±0.10	(1.15 / 1.05 / 0.85)±0.10	
0805	1.50 ± 0.15	2.26 ± 0.20	8.0 ± 0.20	1.75 ± 0.1	3.50 ± 0.05	4.0 ± 0.10	4.0 ± 0.10	2.0 ± 0.05	1.50 +0.1 /-0	(1.05 / 0.95 / 0.75)±0.10	(1.15 / 1.05 / 0.85)±0.10	
1206	1.90 ± 0.15	3.50 ± 0.20	8.0 ± 0.20	1.75 ± 0.1	3.50 ± 0.05	4.0 ± 0.10	4.0 ± 0.10	2.0 ± 0.05	1.50 +0.1 /-0	(0.95 / 0.75)±0.10	(1.05 / 0.85)± 0.10	

NOTE

I. P_0 pitch tolerance over any 10 pitches is ± 0.2 mm

BLISTER TAPE SPECIFICATION

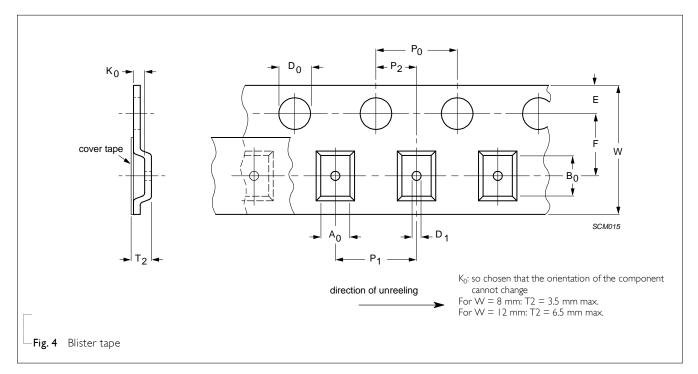


Table 7 Dimensions of blister tape for relevant chip size; see Fig.4

	SYMBOL Un													iit: mm		
size code	A ₀		B ₀		K ₀		W	E	F	ØD ₀	ØDI	$P_0^{(2)}$	Pı	P ₂	Т2	
	Min.	Max.	Min.	Max.	Min.	Max.					Min.				Min,	Max.
0805	1.29	1.65	2.09	2.60	1.25	1.62	8.1 ±0.20	1.75 ±0.1	3.5 ±0.05	1.5 +0.1/-0.0	+0.1/-0.0	4.0 ±0.10	4.0 ±0.10	2.0 ±0.05	1.30	1.67
1206	I.65	2.12	3.30	3.75	1.22	2.15	8.1 ±0.20	1.75 ±0.1	3.5 ±0.05	1.5 +0.1/-0.0	+0.1/-0.0	4.0 ±0.10	4.0 ±0.10	2.0 ±0.05	1.27	2.20
1210	2.55	3.02	3.3 I	3.88	0.97	2.92	8.1 ±0.20	1.75 ±0.1	3.5 ±0.05	1.5 +0.1/-0.0	+0.1/-0.0	4.0 ±0.10	4.0 ±0.10	2.0 ±0.05	1.02	2.97
1808	2.05	2.55	4.80	5.45	1.30	2.45	12.1 ±0.20	1.75 ±0.1	5.5 ±0.05	1.5 +0.1/-0.0	1.5 +0.1/-0.0	4.0 ±0.10	4.0 ±0.10	2.0 ±0.05	1.35	2.50
1812	3.35	3.75	4.70	5.33	0.70	2.40	2. ±0.20	1.75 ±0.1	5.5 ±0.05	1.5 +0.1/-0.0	1.5 +0.1/-0.0	4.0 ±0.10	8.0 ±0.10	2.0 ±0.05	0.75	2.45

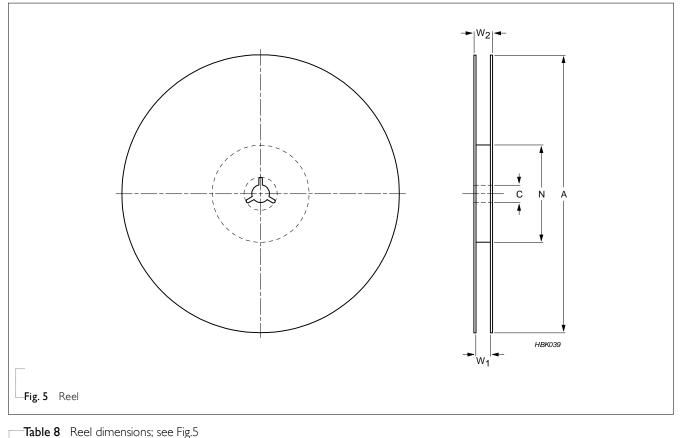
NOTE

I. Typical capacitor displacement in pocket

2. P_0 pitch tolerance over any 10 pitches is ±0.2 mm



REEL SPECIFICATION



······································	SYMBOL									
TAPE WIDTH	A	N	С	W	W _{2max.}					
8 (Ø178 mm/7")	178 ±1.0	60 ±1.0	3 +0.50/-0.20	9.4 ±1.5	14.4					
8 (Ø330 mm/13")	330 ± I.0	100 ± 1.0	13 +0.50/-0.20	9.0 ±0.2	14.4					
12 (Ø178 mm/7")	178 ±1.0	60 ±1.0	13 +0.50/-0.20	3.4 ±1.5	18.4					

PROPERTIES OF REEL

Material: polystyrene

Surface resistance: $<10^{10}$ X/sq.



ELECTRICAL CHARACTERISTICS

X7R DIELECTRIC CAPACITORS; NI/SIN TERMINATIONS

Unless otherwise specified, all test and measurements shall be made under standard atmospheric conditions for testing as given in 5.3 of IEC 60068-1:

- Temperature: 15 °C to 35 °C
- Relative humidity: 25% to 75%
- Air pressure: 86 kPa to 106 kPa

Before the measurements are made, the capacitor shall be stored at the measuring temperature for a time sufficient to allow the entire capacitor to reach this temperature.

The period as prescribed for recovery at the end of a test is normally sufficient for this purpose.

DESCRIPTION Table 9	VALUE
Capacitance tolerance	. 50((1) 100(
X7R	±5% ⁽¹⁾ , ±10%, ±20%
Maximum capacitance change as a function of temperature	
(temperature characteristic/coefficient):	
X7R	±15%
Operating temperature range:	
X7R	−55 °C to +125 °C

NOTE

I. Capacitance tolerance ±5% doesn't available for X7R full product range, please contact local sales force before order



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RATED VOLTAGE AND CAPACITANCE

SIZE		CAPACITANCE	D.F.	RC @ 25 °C	RC @ 125 °C
CODE	(V)	(µF)	F 00/	(Ω· F)	(Ω· F)
	6.3	1.0	5.0%	500	50
0603	10	1.0	5.0%	500	50
	16	1.0	5.0%	100	5
	25	1.0	5.0%	100	5
	10	1.0	5.0%	500	50
	16	1.0	5.0%	500	50
	25	1.0	5.0%	500	50
	50	1.0	5.0%	500	10
0005	10	2.2	5.0%	100	10
0805	16	2.2	5.0%	500	50
	25	2.2	5.0%	500	50
	35	2.2	5.0%	500	50
	10	4.7	10.0%	100	10
	16	4.7	10.0%	100	10
	6.3	10.0	10.0%	100	10
	10	1.0	3.5%	500	10
	25	1.0	3.5%	500	10
	50	1.0	5.0%	500	10
	100	1.0	5.0%	500	10
	16	2.2	5.0%	500	50
1206	25	2.2	5.0%	500	50
	50	2.2	5.0%	500	10
	100	2.2	5.0%	500	10
	6.3	4.7	10.0%	50	5
	10	4.7	10.0%	50	5
	16	4.7	10.0%	50	5
	25	1.0	2.5%	500	50
	50	1.0	2.5%	500	50
	100	1.0	5.0%	500	50
1210	50	2.2	5.0%	500	50
	100	2.2	5.0%	500	50
	25	4.7	10.0%	500	10
	50	4.7	10.0%	500	10
1812	50	1.0	2.5%	500	50
1012	100	1.0	2.5%	500	50

SOLDERING RECOMMENDATION

Table II					
SOLDERING	SIZE				
METHOD	0402	0603	0805	1206	≥ 2 0
Reflow	≥0.1 µF	≥ 1.0 µF	≥ 2.2 µF	≥ 4.7 µF	Reflow only
Reflow/Wave	< 0.1 µF	< 1.0 µF	< 2.2 µF	< 4.7 µF	

SOLDERING CONDITIONS

The lead free MLCCs are able to stand the reflow soldering conditions as below:

- Temperature: above 220 °C
- Endurance: 95 to 120 seconds
- Cycles: 3 times

The test of "soldering heat resistance" is carried out in accordance with the schedule of "MIL-STD-202G-method 210F", "The robust construction of chip capacitors allows them to be completely immersed in a solder bath of 260 °C for 10 seconds". Therefore, it is possible to mount MLCCs on one side of a PCB and other discrete components on the reverse (mixed PCBs). Surface Mount Capacitors are tested for solderability at 245 °C during 2 seconds. The test condition for no leaching is 260°C for 30 seconds.

TESTS AND REQUIREMENTS

Table 12 Test procedures and requirements

TEST	TEST TEST METHOD		PROCEDURE	REQUIREMENTS
Mounting	IEC 60384- 21/22	4.3	The capacitors may be mounted on printed-circuit boards or ceramic substrates	No visible damage
Capacitance	IEC 60384- 21/22	4.5.1	At 20 °C, 24 hours after annealing f = 1 KHz, measuring at voltage 1 V _{rms} at 20 °C	Within specified tolerance
Dissipation Factor (D.F.)	IEC 60384- 21/22	4.5.2	At 20 °C, 24 hours after annealing f = 1 KHz, measuring at voltage 1 V _{rms} at 20 °C	In accordance with specification on table 10
Insulation Resistance	IEC 60384- 21/22	4.5.3	At U _r (DC) for 1 minute	In accordance with specification on table 10

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TEST	TEST METH	HOD	PROCEDURE	REQUIREMENTS
Temperature coefficient		4.6	Capacitance shall be measured by the steps shown in the following table.	Δ C/C: ±15%
ochiciche			The capacitance change should be measured after 5 min at	
			each specified temperature stage.	
			Step Temperature(°C)	
			a 25±2	
			b Lower temperature±3°C	
			c 25±2	
			d Upper Temperature±2°C	
			e 25±2	
			Class II	
			Capacitance Change shall be calculated from the formula as below	
			$\Delta C = \frac{C2 - C1}{C1} \times 100\%$	
			CI: Capacitance at step c	
			C2: Capacitance at step b or d	
High	AEC-Q200	3	Unpowered ; 1000hours @ T=150°C	No visual damage
Temperature -			Measurement at 24±2 hours after test conclusion.	ΔC/C :
Exposure				±10%
				D.F.:
				within initial specified value
				IR:
				within initial specified value
Temperature Cycling	AEC-Q200	4	Preconditioning; 150 +0/–10 °C for 1 hour, then keep for	No visual damage
			24 \pm I hours at room temperature	ΔC/C
				±10%
			1000 cycles with following detail:	D.F. meet initial specified value
			30 minutes at lower category temperature 30 minutes at upper category temperature	IR meet initial specified value
			so minutes at upper category temperature	in meet initial specified value
			Recovery time 24 \pm 2 hours	
Destructive	AEC-Q200	5	Only applies to SMD ceramics.	
Physical Analysis	-		Electrical test not required.	

Product specification $\begin{bmatrix} 13\\ 19 \end{bmatrix}$

Moisture Resistance	AEC-Q200	6	T=24 hrs/per cycle; 10 continuous cycles unpowered. Measurement at 24 ±2 hours after test condition.	No visual damage
			measurement at 24 ±2 hours after test condition.	ΔC/C ±15%
				D.F. Within initial specified value IR Meet initial specified value
	70 - 65 - 60 - 55 - 45 - 40 - 35 - 20 - 15 - 10 - 5 - 0 - -5 - -10 -	AS SPECI		
L Fig. 6 Moistu		7	 Preconditioning, class 2 only: 150 +0/-10 °C /1 hour, then keep for 24 ±1 hour at room temp Initial measure: Parameter: IR Measuring voltage: 1.5V ± 0.1 VDC Note: Series with 100 KΩ & 6.8 KΩ Test condition: 85 °C, 85% R.H. connected with 100 KΩ resistor, applied 1.5V/U_r for 1,000 hours. Recovery: 24 ±2 hours Final measure: IR 	No visual damage after recovery Initial requirement: - Connected to 100 K Ω : C \leq 25 nF: I.R \geq 4,000 M Ω or C \geq 25 nF: (I.R-100 K Ω) \times C \geq 100s. Final measurement: The insulation resistance shall be greater than 10% of initial spec.

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Operational Life	AEC-Q200	8	I. Preconditioning:	No visual damage
			I 50 +0/-10 °C /I hour, then keep for 24 ±1 hour at room temp	ΔC/C
			2. Initial measure:	±15%
			Spec: refer to initial spec C, D, IR	D.F.
			 Endurance test: Temperature: X7R: 125 °C Specified stress voltage applied for 1,000 hours: Applied 150% U_r Recovery time: 24 ±2 hours 	Less than 200% of initial spec. IR The insulation resistance shall be greater than 10% of initial spec
			5. Final measure: C, D, IR	spec
			Note: If the capacitance value is less than the minimum value permitted, then after the other measurements have been made the capacitor shall be preconditioned according to <i>"IEC 60384 4.1"</i> and then the requirement shall be met.	
External Visual	AEC-Q200	9	Any applicable method using × 10 magnification	In accordance with specification
Physical Dimension	AEC-Q200	10	Verify physical dimensions to the applicable device specification.	In accordance with specification
Mechanical	AEC-Q200	13	Three shocks in each direction shall be applied along the three	ΔC/C
Shock			mutually perpendicular axes of the test specimen (18 shocks)	±10%
			Peak value: 1,500 g's Duration: 0.5 ms	D.F.
			Velocity change: 15.4 ft/s	Within initial specified value
			Waveform: Half-sin	IR
				Within initial specified value
Vibration	AEC-Q200	14	5 g's for 20 minutes, 12 cycles each of 3 orientations.	ΔC/C

Use 8" \times 5" PCB, 0.31" thick 7 secure points on one long side

and 2 secure points at corners of opposite sides. Parts

mounted within 2" from any secure point. Test from

10-2000 Hz.

Feb. 25, 2021 V.0

D.F: meet initial specified value

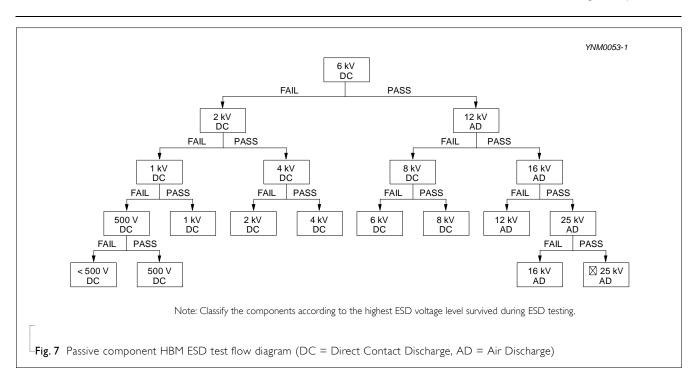
IR meet initial specified value

Resistance to Soldering Heat	AEC-Q200	15	Precondition: 150 +0/–10 °C for 1 hour, then keep for 24 ± 1 hours at room temperature Preheating: for size ≤ 1206 : 120 °C to 150 °C for 1 minute Preheating: for size >1206 : 100 °C to 120 °C for 1 minute and 170 °C to 200 °C for 1 minute Solder bath temperature: 260 ± 5 °C Dipping time: 10 ± 0.5 seconds Recovery time: 24 ± 2 hours	Dissolution of the end face plating shall not exceed 25% of the length of the edge concerned ΔC/C ±10% D.F. within initial specified value
				IR within initial specified value
Thermal Shock	AEC-Q200	16	 Preconditioning: Preconditioning: 150 +0/-10 °C /1 hour, then keep for 24 ±1 hour at room temp Initial measure: Spec: refer to initial spec C, D, IR Rapid change of temperature test: X7R: -55 °C to +125 °C; 300 cycles 15 minutes at lower category temperature; 15 minutes at upper category temperature. Recovery time: X7R: 24 ±2 hours Final measure: C, D, IR 	No visual damage ΔC/C 15% D.F: meet initial specified value IR meet initial specified value



AEC-Q200 17 Per AEC-Q200-002

A component passes a voltage level if all components stressed at that voltage level pass.



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 ×7R
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Solderability	AEC-Q200	18	Preheated to a temperature of 80 °C to 140 °C and maintained for 30 seconds to 60 seconds.	The sold 95% of t terminat	he criti			
			Test conditions for lead containing solder alloy					
			Temperature: 235 ±5 °C Dipping time: 2 ±0.2 seconds					
			Depth of immersion: 10 mm					
			Alloy Composition: 60/40 Sn/Pb					
			Number of immersions: 1					
			Test conditions for lead-free containing solder alloy					
			Temperature: 245 ±5 °C					
			Dipping time: 3 ±0.3 seconds Depth of immersion: 10 mm					
			Alloy Composition: SAC305					
			Number of immersions: I					
Electrical Characterization						ΔC/C		
			summary to show Min, Max, Mean and Standard deviation at room as well as Min and Max operating temperatures.	±15%				
			X7R: -55 °C to +125 °C Normal temperature: 20 °C					
Board Flex	AEC-Q200	21	Part mounted on a 100 mm X 40 mm FR4 PCB board, which	No visib	le dam	age		
			is 1.6 \pm 0.2 mm thick and has a layer-thickness 35 μ m \pm 10 μ m.	ΔC/C				
			Part should be mounted using the following soldering reflow profile.	±10%				
			Conditions:					
			Bending 2 mm at a rate of 1 mm/s, radius jig 340 mm		Dimon	sion(m	m)	
			Test Substrate:	Туре	a	b	c	
			b ↓ 04.5 ^{YNSC147}	0201	0.3	0.9	0.3	
				0402	0.4	1.5	0.5	
				0603	1.0	3.0	1.2	
				0805	1.2	4.0	1.65	
				1206	2.2	5.0	1.65	
			* - ≠					
				1210	2.2	5.0	2.0	

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Terminal Strength	AEC-Q200	22	With the component mounted on a PCB obtained with the device to be tested, apply a 17.7N (1.8Kg) force to the side of a device being tested. This force shall be applied for 60+1 seconds. Also the force shall be applied gradually as not to apply a shock to the component being tested. * Apply 2N force for 0402 size.	Magnification of 20X or greater may be employed for inspection of the mechanical integrity of the device body, terminals and body/terminal junction. Before, during and after the test, the device shall comply with all electrical requirements stated in this specification.
Beam Load Test	AEC-Q200	23	Place the part in the beam load fixture. Apply a force until the part breaks or the minimum acceptable force level required in the user specification(s) is attained.	≤ 0805 Thickness > 0.5mm: 20N Thickness ≤ 0.5mm: 8N ≥ 1206 Thickness ≥1.25 mm: 54N Thickness < 1.25 mm: 15N
Voltage Proof			 Specified stress voltage applied for 1~5 seconds Ur ≤ 100 V: series applied 2.5 Ur Charge/Discharge current is less than 50 mA 	No breakdown or flashover

REVISION HISTORY

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 0	Feb. 25, 2021	-	- New

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